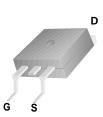


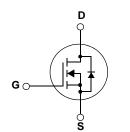
FDB039N06 N-Channel PowerTrench[®] MOSFET 60V, 174A, 3.9mΩ

Features

- $R_{DS(on)} = 2.95 m\Omega$ (Typ.) @ $V_{GS} = 10V$, $I_D = 75A$
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant







MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain to Source Voltage			60	V	
V _{GSS}	Gate to Source Voltage			±20	V	
I _D		-Continuous (T _C = 25 ^o C, Silicion Lin	nited)	174*		
	Drain Current	-Continuous (T _C = 100 ^o C, Silicion Li	mited)	123*	A	
		-Continuous (T _C = 25 ^o C, Package L	imited)	120		
I _{DM}	Drain Current	- Pulsed (Note 1)	696	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			872	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	7.0	V/ns	
P _D	Dewer Dissingtion	$(T_{\rm C} = 25^{\rm o}{\rm C})$		231	W	
	Power Dissipation	- Derate above 25°C		1.54	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

Thermal Characteristics

Symbol	Parameter	Ratings	Units
R_{\thetaJC}	Thermal Resistance, Junction to Case	0.65	
D	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper)	62.5	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (1 in ² pad of 2 oz copper)	40	

• DC to DC convertors / Synchronous Rectification

maintain superior switching performance.

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been

especially tailored to minimize the on-state resistance and yet

General Description

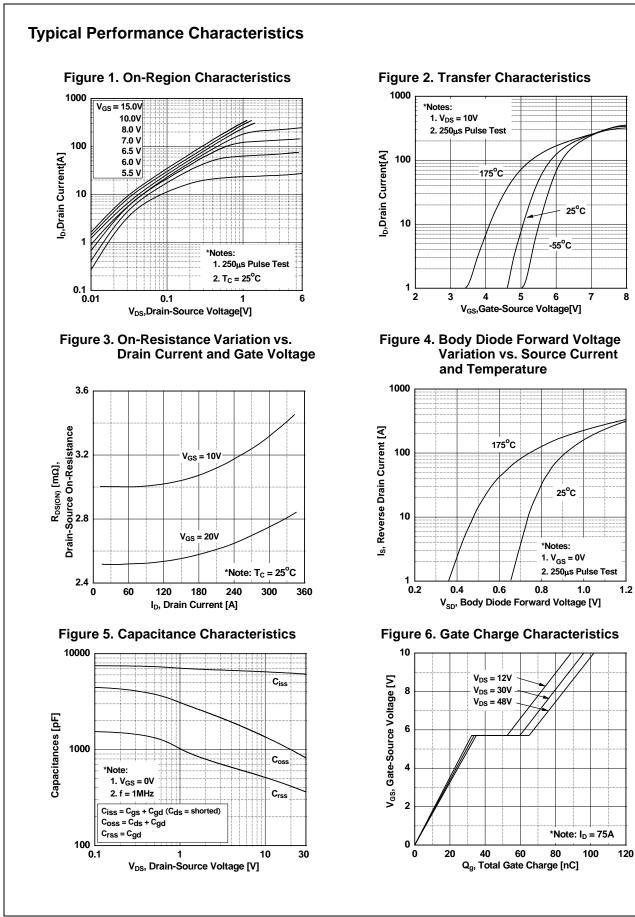
Application

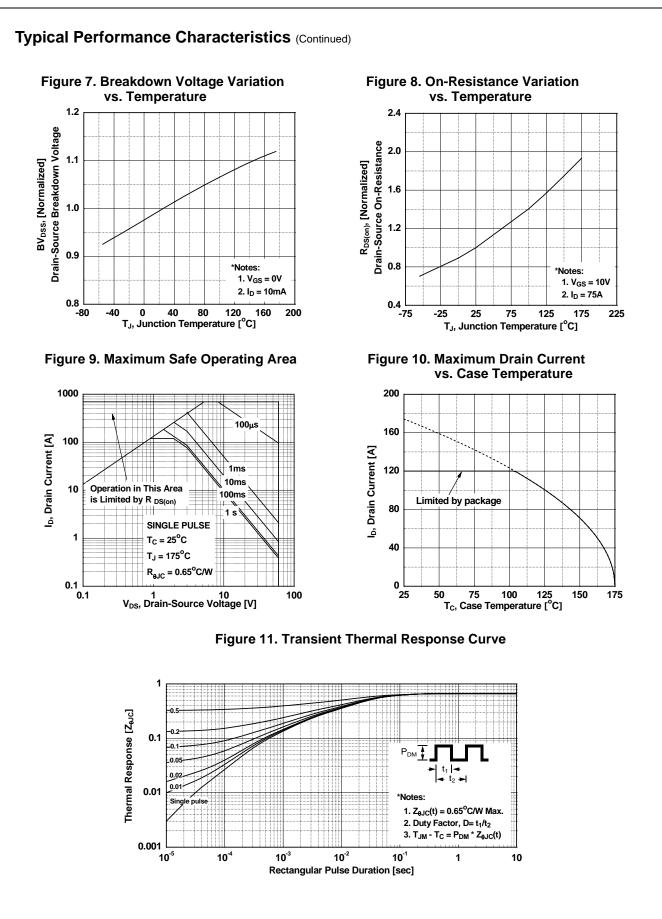
May 2012

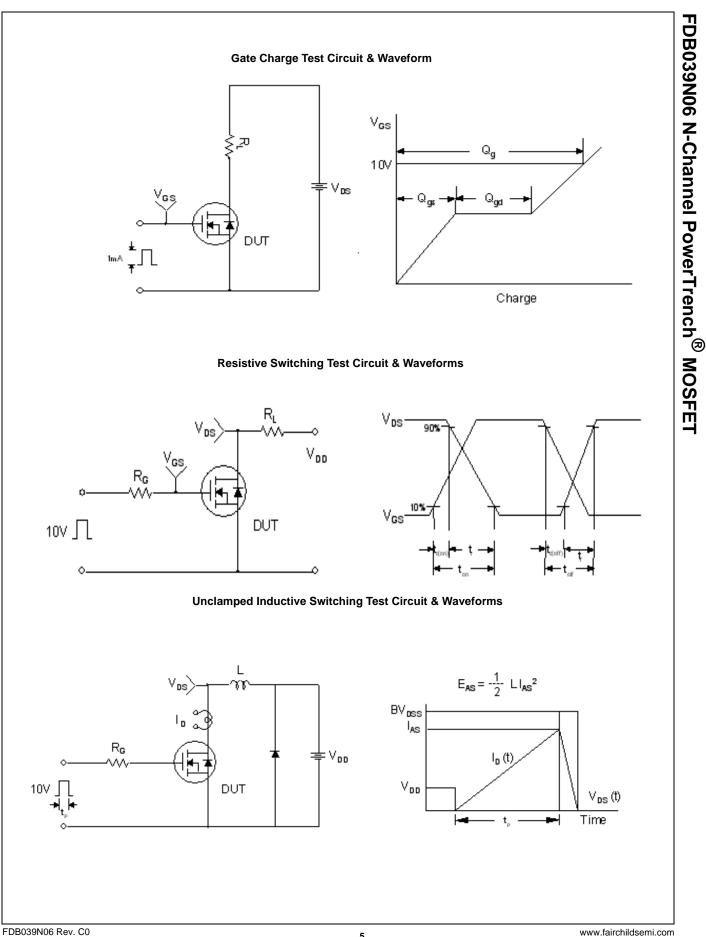
Device Marking FDB039N06		Device	Packag	e Reel S	lize	Tape	Width		Quantity	
		FDB039N06		TO-263 Tube			-		50	
Electrica	l Chara	acteristics T _c =	25ºC unless	otherwise noted				L		
Symbol		Parameter		Test Con	ditions		Min.	Тур.	Max.	Units
Off Charac	teristics	6								
BV _{DSS}	Drain to Source Breakdown Voltage		$I_{D} = 250 \mu A, V_{GS} = 0V, T_{C} = 25^{\circ}C$			60	-	-	V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient		$I_D = 250 \mu A$, Referenced to $25^{\circ}C$		-	0.04	-	V/ºC		
I _{DSS}	Zero Gate Voltage Drain Current		nt	$V_{DS} = 60V, V_{GS} = 0V$			-	-	1	۸
			:11	$V_{DS} = 60V, V_{GS} = 0V, T_{C} = 150^{\circ}C$			-	- 5	500	μΑ
I _{GSS}	Gate to	Gate to Body Leakage Current		$V_{GS} = \pm 20V, V_{DS} = 0V$			-	-	±100	nA
On Charac	teristics									
V _{GS(th)}	Gate Threshold Voltage			V _{GS} = V _{DS} , I _D = 250μA			2.5	3.5	4.5	V
R _{DS(on)}		rain to Source On Res	istance	$V_{GS} = 10V, I_D = 75$			-	2.95	3.9	mΩ
9FS		Forward Transconductance		$V_{DS} = 10V, I_D = 75A$			-	169	-	S
Dynamic C C _{iss} C _{oss}	Input Ca	pacitance Capacitance		V _{DS} = 25V, V _{GS} = 0V f = 1MHz		-	6190 900	8235 1195	pF pF	
C _{rss}	Reverse	Transfer Capacitance				-	385	580	pF	
Q _{g(tot)}	Total Ga	te Charge at 10V		V _{DS} = 48V, I _D = 75A			-	102	133	nC
Q _{gs}	Gate to	Source Gate Charge		$V_{GS} = 10V$			-	32	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge		(Note 4)		Note 4)	-	32	-	nC
Switching	Charact	eristics								
t _{d(on)}	Turn-On	Delay Time		$V_{DD} = 30V, I_D = 75A$ $V_{GS} = 10V, R_{GEN} = 4.7\Omega$ (Note 4)			-	30	70	ns
t _r	Turn-On	Rise Time					-	40	90	ns
t _{d(off)}	Turn-Off	Delay Time					-	55	120	ns
t _f	Turn-Off	Fall Time				Note 4)	-	24	58	ns
Drain-Sou	rce Diod	e Characteristic	5							
I _S	Maximum Continuous Drain to Source Diod			e Forward Current			-	-	174	A
I _{SM}	Maximum Pulsed Drain to Source Diode Fo		rce Diode For	orward Current			-	-	696	Α
V _{SD}	Drain to	Source Diode Forward	I Voltage	V _{GS} = 0V, I _{SD} = 75	4		-	-	1.3	V
t _{rr}	Reverse	Recovery Time		$V_{GS} = 0V, I_{SD} = 75.$			-	41	-	ns
Q _{rr}		Recovery Charge		$dI_{\rm F}/dt = 100A/\mu s$			-	47	-	nC

FDB039N06 N-Channel PowerTrench[®] MOSFET



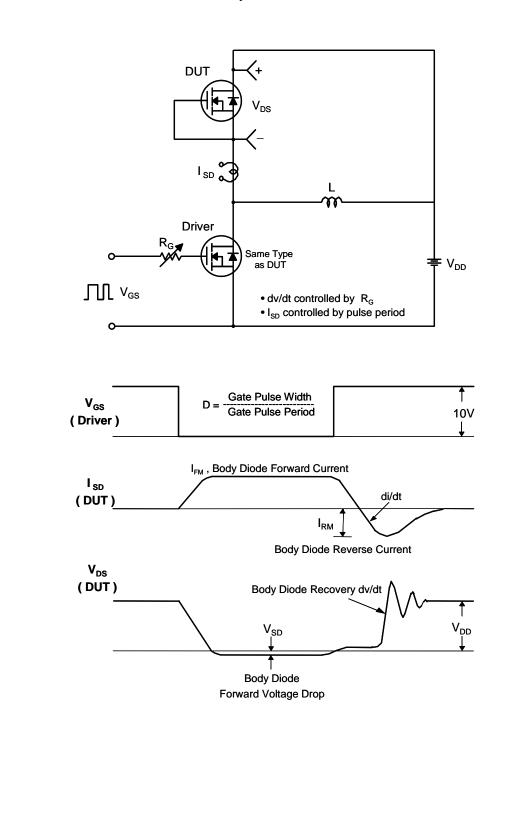


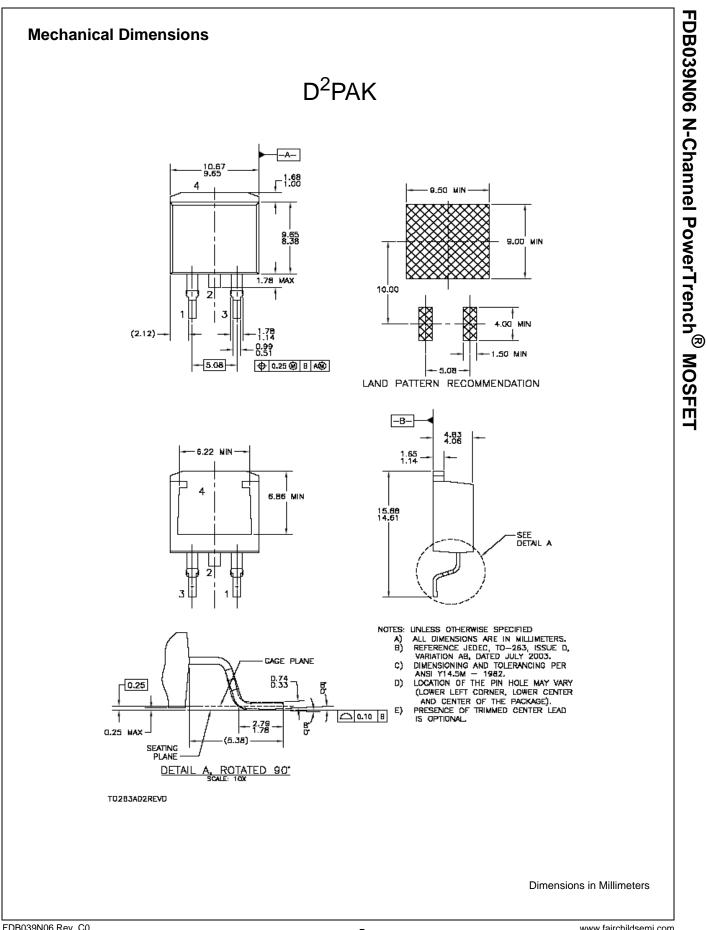




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